



SMD Comm X8G HT150C Flex, Ceramic, 75 pF, 5%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



| General Information | | |
|--------------------------|--|--|
| Series | SMD Comm X8G HT150C Flex | |
| Style | SMD Chip | |
| Description | SMD, MLCC, High Temperature, Ultra-Stable | |
| Features | High Temperature, Ultra-Stable | |
| RoHS | Yes | |
| Termination | Flexible Termination | |
| Marking | No | |
| AEC-Q200 | No | |
| Typical Component Weight | 4.6 mg | |
| Shelf Life | 78 Weeks | |
| MSL | 1 | |

| Dimensions | |
|------------|------------------|
| Chip Size | 0603 |
| L | 1.6mm +/-0.17mm |
| W | 0.8mm +/-0.15mm |
| Т | 0.8mm +/-0.15mm |
| S | 0.4mm MIN |
| В | 0.45mm +/-0.15mm |
| | |

| W | 0.8mm +/-0.15mm |
|--------------------------|------------------|
| Т | 0.8mm +/-0.15mm |
| S | 0.4mm MIN |
| В | 0.45mm +/-0.15mm |
| | |
| Packaging Specifications | |

| 3 | 0.411111111111 | Dielectric Withstanding V |
|--------------------------|------------------------|--------------------------------------|
| В | 0.45mm +/-0.15mm | Temperature Range |
| | | Temp. Coefficient |
| Packaging Specifications | | Capacitance Change with |
| Packaging | T&R, 330mm, Paper Tape | Reference to +25°C and Applied (TCC) |
| Packaging Quantity | 15000 | Dissipation Factor |
| | | Aging Rate |

| Specifications | |
|--|--|
| Capacitance | 75 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Tolerance | 5% |
| Voltage DC | 250 VDC |
| Dielectric Withstanding Voltage | 625 VDC |
| Temperature Range | -55/+150°C |
| Temp. Coefficient | X8G |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 100 GOhms |

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